WHAT IS CLAIMED IS:

1. A flexible printed circuit board comprising a component mount section, which an electronic component is mounted on, and a cable section, which connects to the component mount section;

circuit patterns being provided on the cable section, and covered by a soft laminated adhesive.

- 2. The flexible printed circuit board as described in Claim 1, the laminated adhesive comprising an adhesive which maintains an average thickness at the time of lamination.
- The flexible printed circuit board as described in Claim
 the laminated adhesive comprising a polyamide adhesive.
- 4. The flexible printed circuit board as described in Claim 1, the laminated adhesive comprising an acrylic adhesive.
- 5. A method for manufacturing a flexible printed circuit board having a component mount section, which comprises an outer-layer material laminated on an inner-layer material with an insulating cover therebetween, and a cable section, which comprises the inner-layer material covered by the insulating cover and connects to the component mount section, the method comprising the step of:

covering the inner-layer material of the component mount section and the cable section with a soft laminated adhesive.